

DATASHEET

ES-2835-1036V-L1-XXXX

ES-2835-1036V-L1-XXXX Datasheet

This 2835 LED Light Source is a high performance energy efficient device which can handle high thermal and high driving current. The small package outline and high intensity make it an ideal choice for LED panel light, LED bulb light, LED tube light, backlighting and etc.

This part has a foot print that is compatible to most of the same size LED in the market today.



FEATURES

- Available in Cool White, Neutral White and Warm White color
- ANSI-compatible chromaticity bins
- High luminous Intensity and high efficiency
- Compatible with reflow soldering process
- Low thermal resistance
- Long operation life
- Wide viewing angle at 120°
- Silicone encapsulation
- Environmental friendly, RoHS compliance

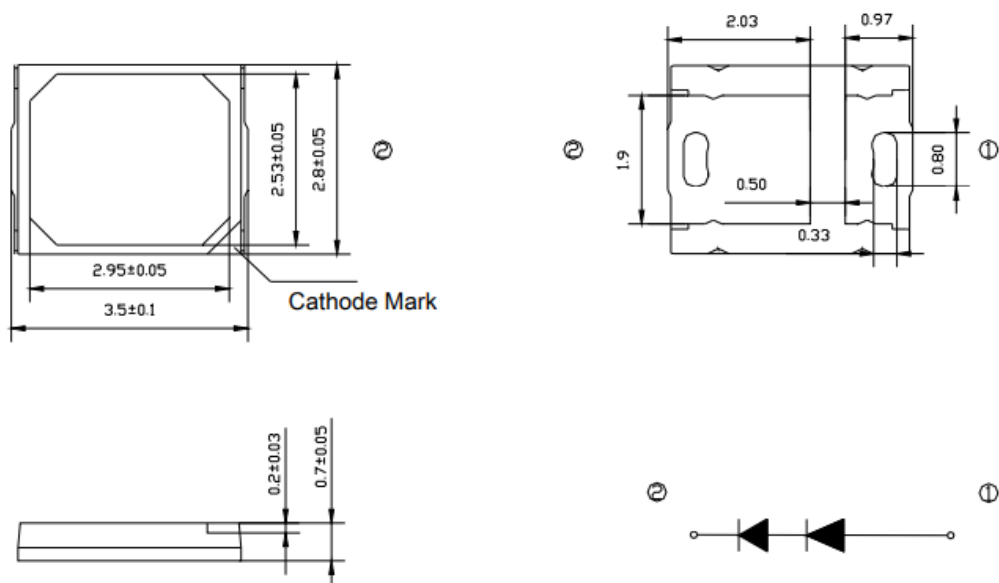
APPLICATIONS

- Flat panel light
- Backlighting
- LED tube light
- LED bulb light
- Interior & exterior automotive lighting
- Decorative and landscape lighting
- Signage and channel letter
- Reading lamp
- Decorating and entertainment lighting
- Architectural lighting

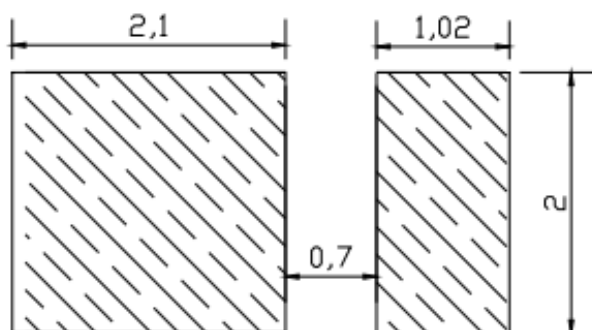
Note:

The information in this document is subject to change without notice.

PACKAGE DIMENSIONS



Recommended Solder Pad Design



Notes:

1. All dimensions in millimeters.
2. Thickness tolerance of copper plate is ± 0.02 mm.
3. Thickness tolerance of product is ± 0.05 mm.
4. Tolerance is ± 0.1 mm unless otherwise noted.

ABSOLUTE MAXIMUM RATINGS (T_j=25°C)

Parameter	Symbol	Value	Unit
Forward current	I _F	30	mA
Peak Forward Current	I _{FP}	50	mA
Reverse Voltage	V _R	40	V
Power Dissipation	P _d	1128	mW
Operating Temperature	T _{opr}	-40~+85	°C
Storage Temperature	T _{stg}	-40~+100	°C
Soldering Temperature	T _{sld}	Reflow Soldering: 260°C for 10 seconds	
LED Junction Temperature	T _j	115	°C

I_{FP} Conditions: Pulse Width ≤10msec. and Duty ≤1/10.

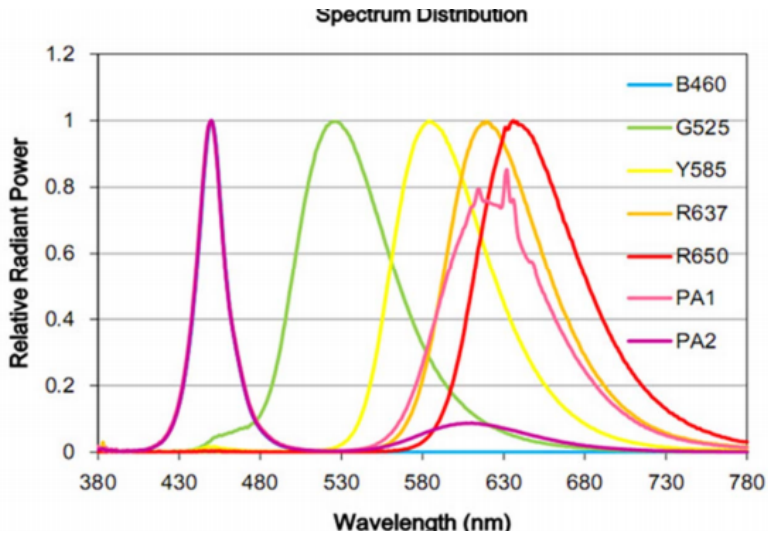
CHARACTERISTICS (T_j=25°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V _F	I _F =30mA	34	--	39	V
Viewing Angle	2θ _{1/2}	I _F =30mA	--	120	--	deg.
Luminous Intensity	Φ _v	I _F =30mA	12	--	200	lm
Thermal Resistance (Junction to Solder Point)	R _{th-js}	I _F =30mA	--	15	--	°C/W

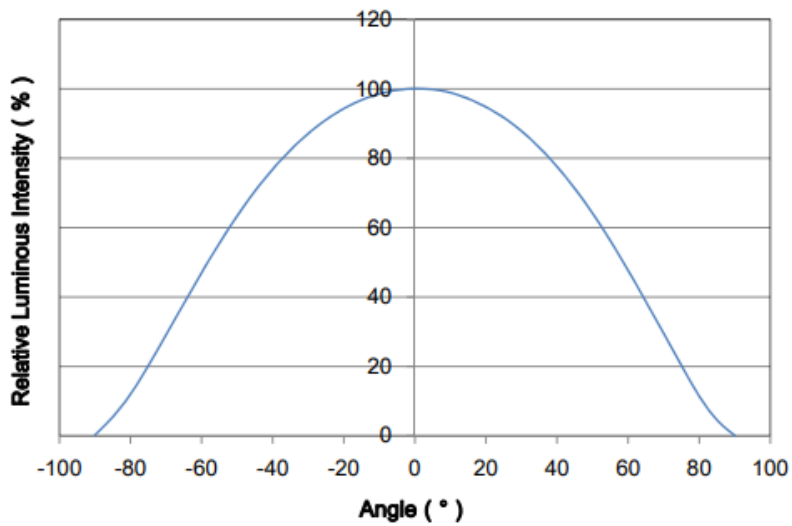
Note:

1. Luminous flux is measured with an accuracy of ± 10%.
2. Chromaticity coordinate bins are measured with an accuracy of ± 0.01.
3. CRI is measured with an accuracy of ± 2.
4. Some color and CRI bins may have limited availability, please contact us before ordering.
5. All measurements were made under the standardized environment of Everstar

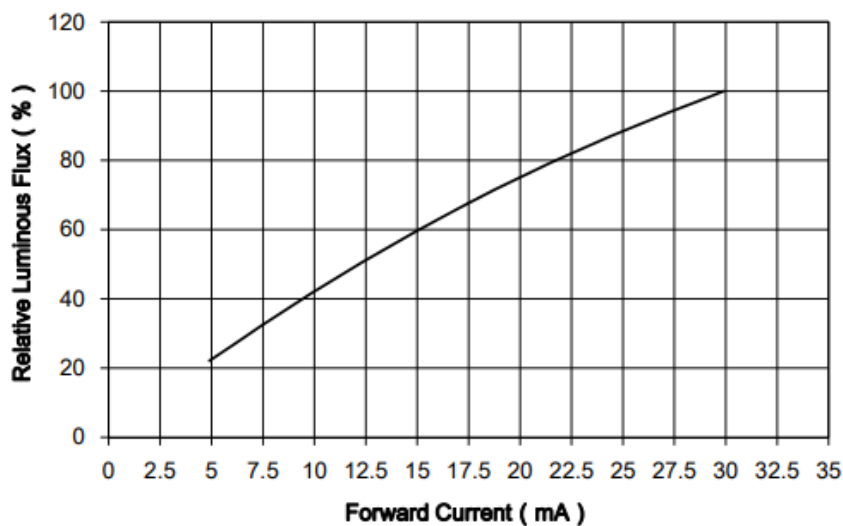
RELATIVE SPECTRAL POWER DISTRIBUTION (T_j=25°C)



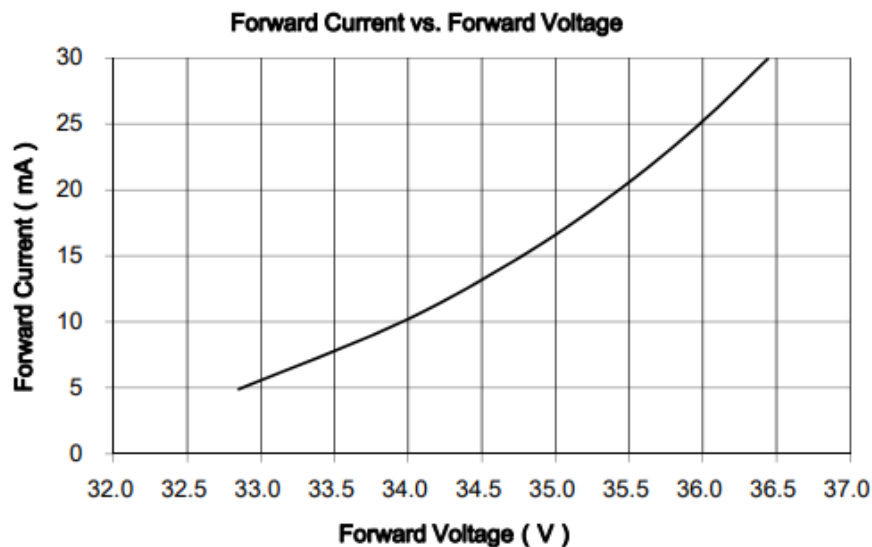
TYPICAL SPATIAL DISTRIBUTION



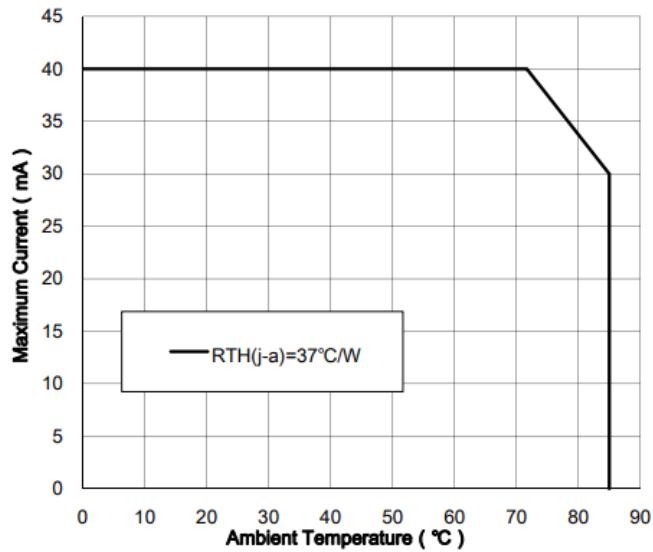
RELATIVE LUMINOUS FLUX VS. CURRENT ($T_j=25^{\circ}\text{C}$)



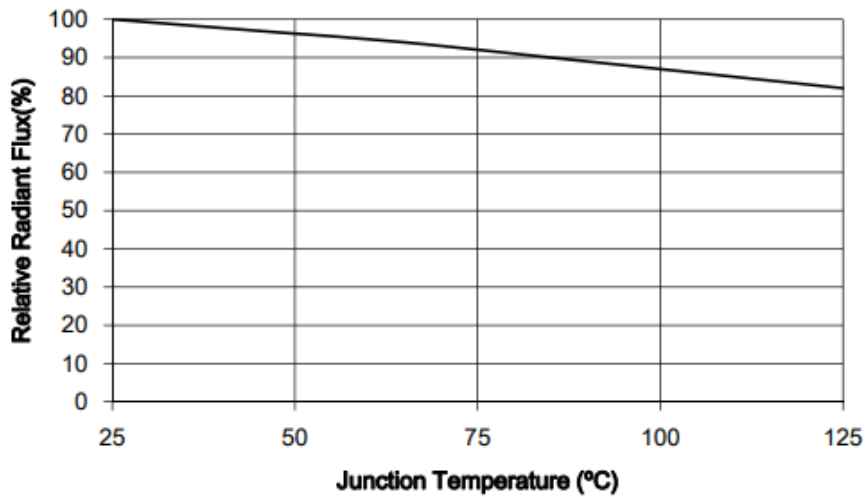
ELECTRICAL CHARACTERISTICS ($T_j=25^{\circ}\text{C}$)



MAXIMUM CURRENT VS. AMBIENT TEMPERATURE



RELATIVE RADIANT FLUX VS. JUNCTION TEMPERATURE



SORTING RANKS

(1) Luminous Intensity ($T_j=25^{\circ}\text{C}$)

Part No.	Condition	Rank	Unit
ES-2835-1036V-L1-R637	30mA	L1 30-40	lm
ES-2835-1036V-L1-G525		L1 160-180	
ES-2835-1036V-L1-B460		L1 18-22	
ES-2835-1036V-L1-PA01		L1 90-100	
ES-2835-1036V-L1-Y585		L1 125-135	

(2) Forward Voltage ($T_j=25^{\circ}\text{C}$)

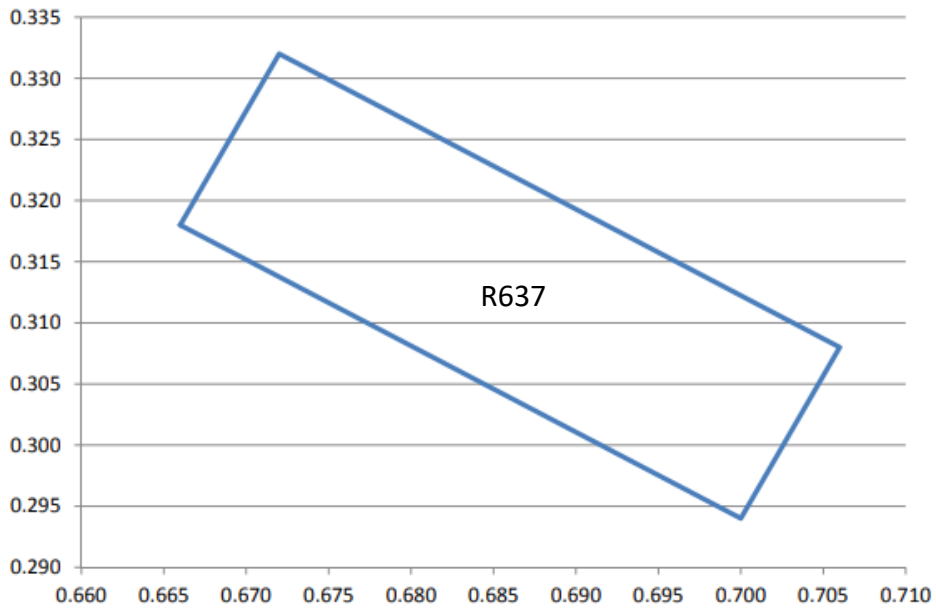
Rank	Condition	Min.	Max.	Unit
J4	30mA	34	35	V
J5		35	36	
J6		36	37	
J7		37	38	
J8		38	39	

Note:

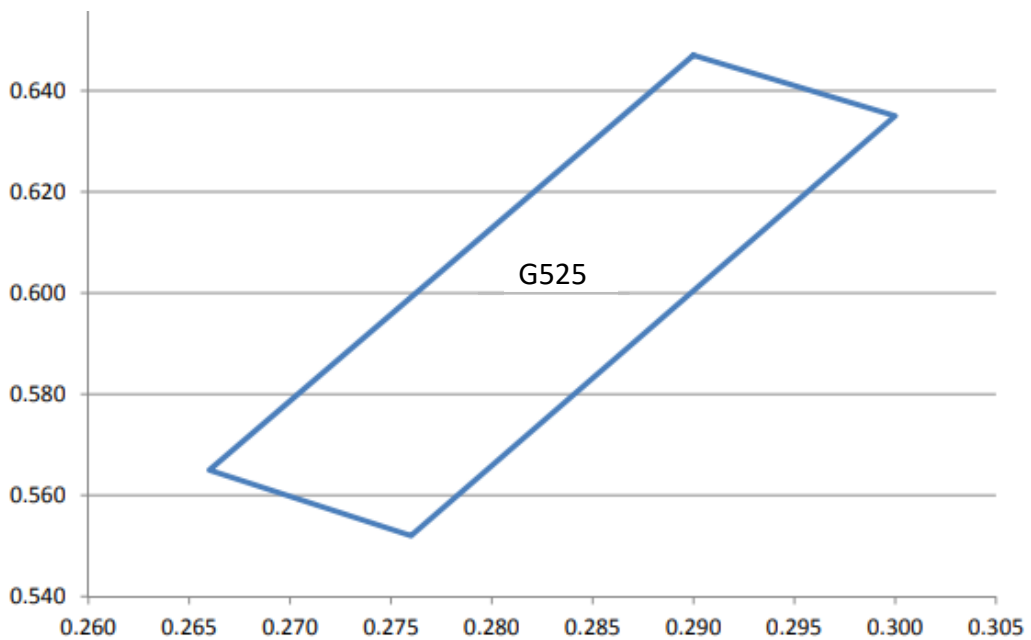
1. 10% tolerance for luminous intensity may be caused by measurement inaccuracy.
2. Measurement Uncertainty of the Forward Voltage : $\pm 3\%$

(3) Chromaticity Bins

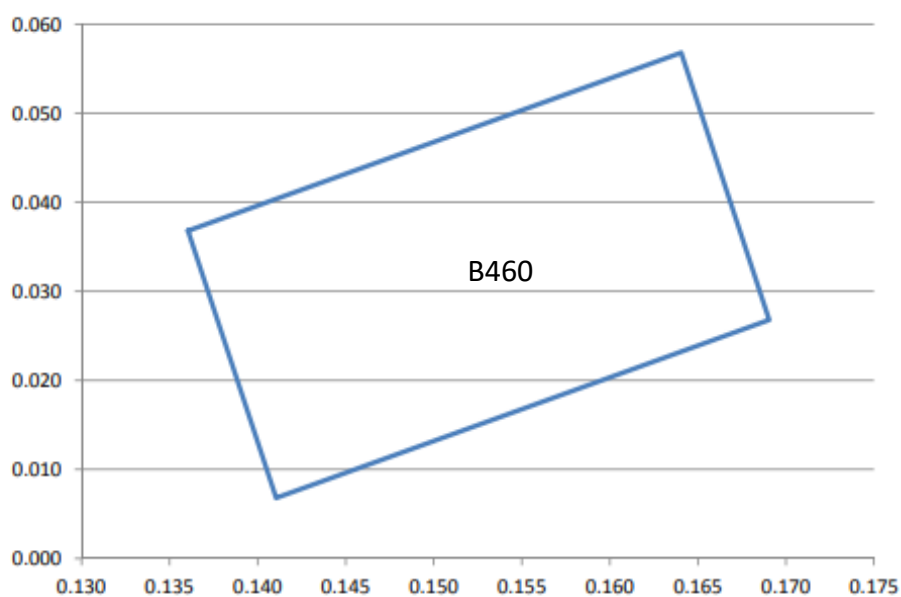
Rank		ES-2835-1036V-L1-R637			
Bin Code		Color Coordinates(X,Y)			
R637	X	0.6660	0.6720	0.7060	0.7000
	Y	0.3180	0.3320	0.3080	0.2940



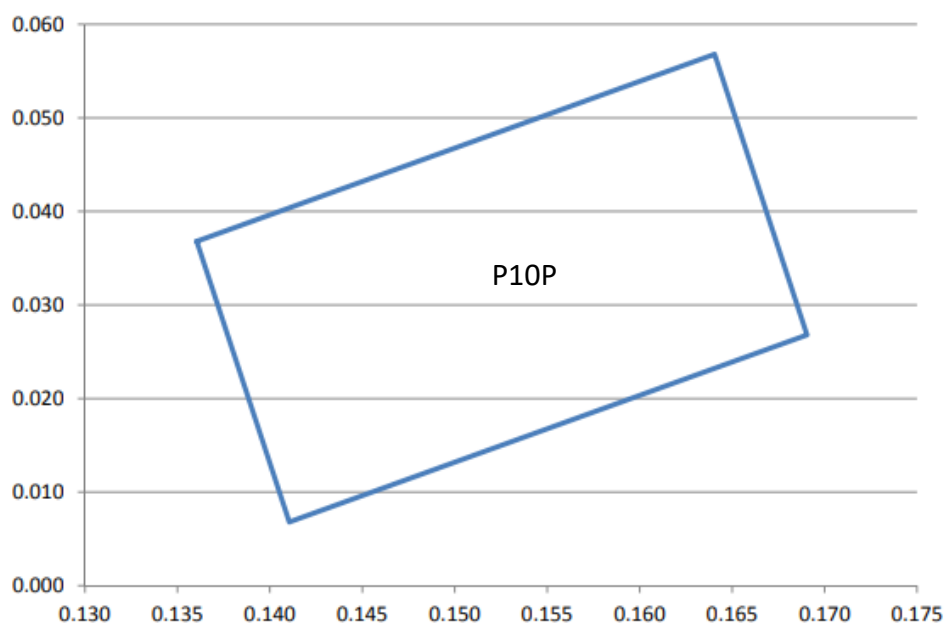
Rank		ES-2835-1036V-L1-G525			
Bin Code		Color Coordinates(X,Y)			
G525	X	0.2900	0.2660	0.2760	0.3000
	Y	0.6470	0.5650	0.5520	0.6350



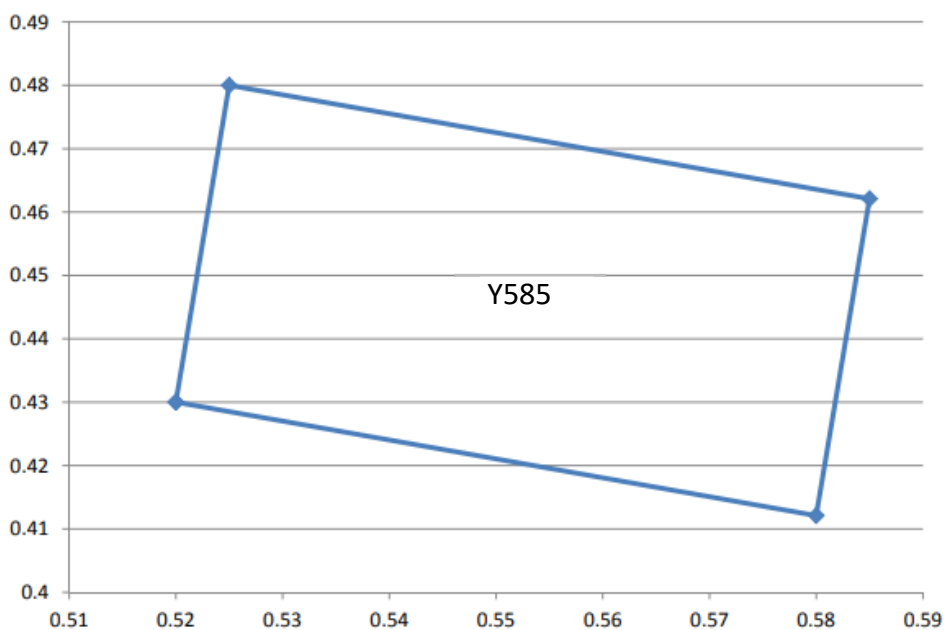
Rank		ES-2835-1036V-L1-B460			
Bin Code		Color Coordinates(X,Y)			
B460	X	0.1361	0.1411	0.1691	0.1641
	Y	0.0368	0.0068	0.0268	0.0568



Rank		ES-2835-1036V-L1-P10P			
Bin Code		Color Coordinates(X,Y)			
P10P	X	0.3790	0.3890	0.4320	0.4220
	Y	0.2720	0.2420	0.2720	0.3020



Rank		ES-2835-1036V-L1-Y585			
Bin Code		Color Coordinates(X,Y)			
Y585	X	0.52	0.58	0.585	0.525
	Y	0.43	0.4121	0.4621	0.48



REFLOW SOLDERING CHARACTERISTICS

For Reflow Process

Preheating : $140^{\circ}\text{C} \sim 160^{\circ}\text{C} \pm 5^{\circ}\text{C}$, within 2 minutes.

Operation heating : 260°C (Max.) within 10 seconds. (Max)

Gradual Cooling (Avoid quenching).

Lead solder		Lead-free solder	
Pre-heat	120-150 $^{\circ}\text{C}$	Pre-heat	150-200 $^{\circ}\text{C}$
Pre-heat time	120 sec.Max.	Pre-heat time	120 sec.Max.
Peak Temperature	240 $^{\circ}\text{C}$ Max.	Peak Temperature	260 $^{\circ}\text{C}$ Max.
Soldering time condition	10 sec.Max.	Soldering time condition	10 sec.Max.

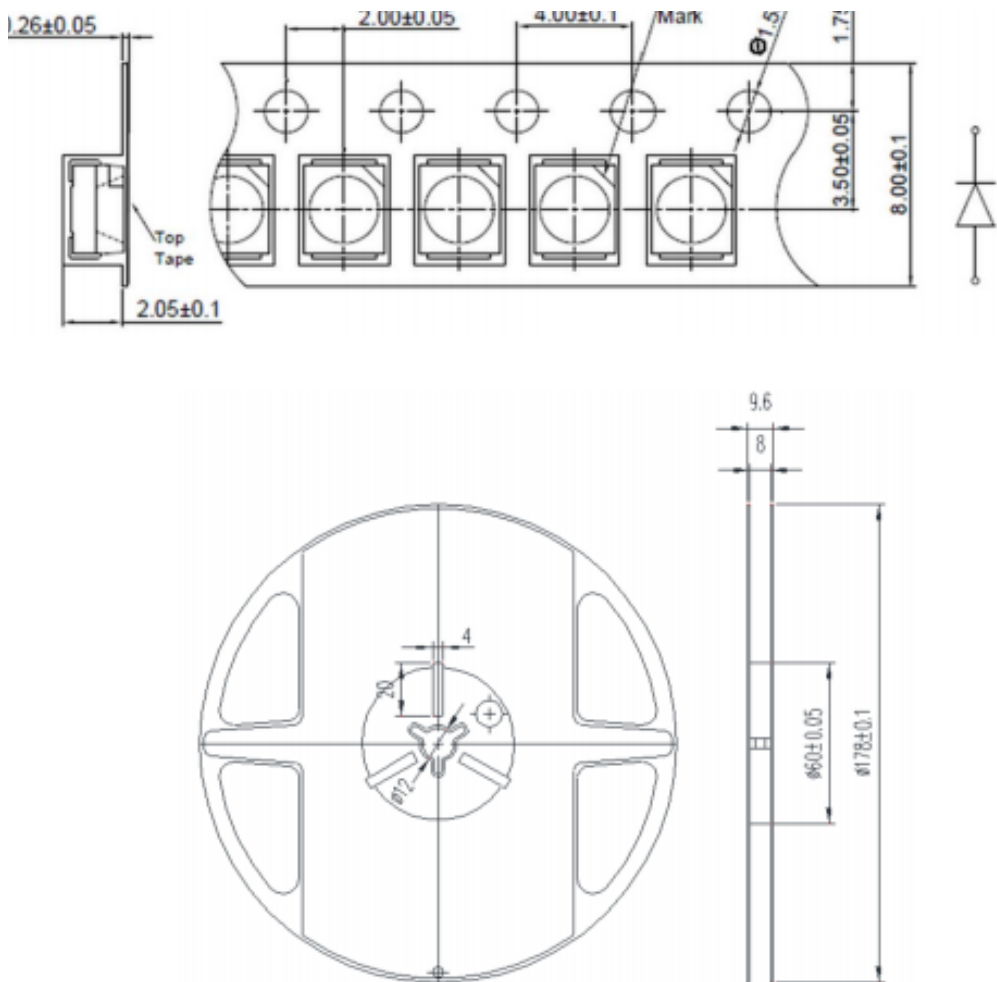
<p style="text-align: center;">Lead Solder</p>		<p style="text-align: center;">Lead-free Solder</p>	
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Note:

The encapsulated material of the LEDs is silicone . Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will be influence to the reliability of the LEDs. Precautions should

be taken to avoid the strong pressure on the encapsulated part. So when using the picking up nozzle, the pressure on the silicone resin should be proper.

TAPE AND REEL

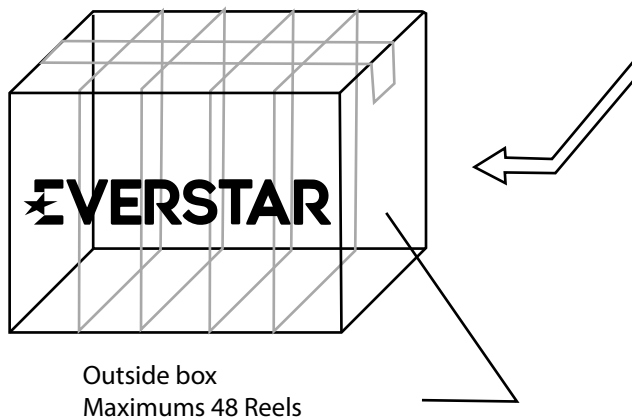
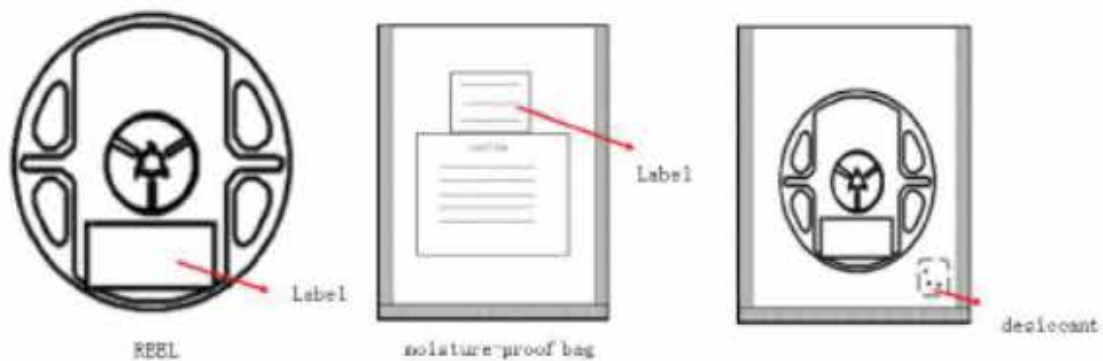


Note: The tolerances unless mentioned is $\pm 0.1\text{mm}$, Unit=mm

Notes:

- (1) Quantity : 4,000pcs/Reel
- (2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be $\pm 0.2\text{mm}$
- (3) Adhesion Strength of Cover Tape : Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at the angle of 10° to the carrier tape
- (4) Package : P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof Package.

PACKAGING



RELIABILITY TEST ITEMS

Test Items	Test Duration	Number of Damaged
Steady State Operating Life of High Temperature (HTOL) Ts=85°C, IF=Max	1000hrs	0/20
Steady State Operating Life of Low Temperature (LTOL) Ta=-40°C, IF=Max	1000hrs	0/20
Pulse Wet Operating Life of High Temperature (PWHTOL) 60°C/90%RH, IF 30mins ON/30min OFF	500hrs	0/20
High Temperature Storage (HTS) °C 80°C	1000hrs	0/20
Low Temperature Storage (LTS) -40°C	1000hrs	0/20
Thermal Shock (TS) -45°C~125°C 30min dwell 20sec transfer	100cycles	0/20
Solder Resistance (SR) 265°C, 3X MSL	5sec	0/20
Solder Ability (SA) 245°C 5sec, 95% coverage	5sec	0/11
Mechanical Shock (MS) 1500G 0.5msec pulse shock	Each 6 axis	0/6
Random Vibration (RV) 6G RMS, 10-2000Hz, 10min	Per axis	0/6
Variable Vibration Frequency (VVF) 10-2000-10Hz, log or linear sweep rate, 20G for 1 min, 1.5mm each apply 3x per axis over	6hrs	0/6
Salt Spread (SS) 35°C, 30g/m2/day	48hrs	0/11

Item	Symbol	Test Condition	Criteria for Judgment Min. Max.
Forward	VF	IF=Typical Current	U.S.L x1.1
Luminous Flux	Im	IF=Typical Current	L.S.L x0.7
CCX&CCY	x.y	IF=Typical Current	Shift<0.02

PRECAUTION FOR USE

- (1) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When washing is required, IPA should be used.
- (2) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.
- (3) LEDs must be stored to maintain a clean atmosphere. If the LEDs are stored for 3 months or more after being shipped from Everstar, a sealed container with a nitrogen atmosphere should be used for storage.
- (4) The LEDs must be used within seven days after opening the moisture proof packing. Repack unused Products with anti-moisture packing, fold to close any opening and then store in a dry place.
- (5) The appearance and specifications of the product may be modified for improvement without notice.
- (6) This LED is sensitive to the static electricity and surge. It is recommended to use a wrist Band or anti-electrostatic glove when handling the LEDs.
- (7) On manual soldering, a solder tip must be needed as grounded for usage. If over voltage which exceeds the absolute maximum rating is applied to LEDs, it will cause damage LEDs and result in destruction. Damaged LEDs will show some unusual characteristics such as leak current remarkably increase, turn-on voltage becomes lower and the LEDs get unlighted at low current.